

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
BIAO TANG	06/18/2021
HAIPING LIU	06/18/2021
ZHONGSHAN FENG	06/18/2021
RECEIVING PARTY DATA	
Name:	CHONGQING KONKA PHOTOELECTRIC TECHNOLOGY RESEARCH INSTITUTE CO., LTD.
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City:	CHONGQING
State/Country:	CHINA
Postal Code:	402760
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17362256
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NAME OF SUBMITTER:	JOSHUA L. PRITCHETT
SIGNATURE:	/JOSHUA L. PRITCHETT/
DATE SIGNED:	06/29/2021
Total Attachments: 1	
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ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

- 1) Biao TANG
- 2) Haiping LIU
- 3) Zhongshan FENG
- 4)
- 5)
- 6)

who has made a certain new and useful invention, hereby sells, assigns and transfers unto

CHONGOING KONKA PHOTOELECTRIC TECHNOLOGY RESEARCH INSTITUTE CO., LTD. having a place of business at (Factory 1) No. 69, Wushan Road, Biqian Street, Bishan District, Chongqing 402760, China

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

SPHERICAL FLIP-CHIP MICRO-LED, METHOD FOR MANUFACTURING THE SAME, AND DISPLAY PANEL

(a) for which an application for United States Letters Patent was filed on _____, and identified by United States Patent Application No. _____; or

(b) for which an application for United States Letters Patent was executed on _____, and the undersigned hereby authorizes and requests the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefore and any and all extensions, divisions, reissues, continuations, or continuations-in-part thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agrees that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agrees to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the date indicated aside my signature:

1) Biao TANG
Name: Biao TANG

2021.06.18
Date:

2) Haiping LIU
Name: Haiping LIU

2021.06.18
Date:

3) Zhongshan FENG
Name: Zhongshan FENG

2021.06.18
Date:

4) _____
Name:

Date:

5) _____
Name:

Date: